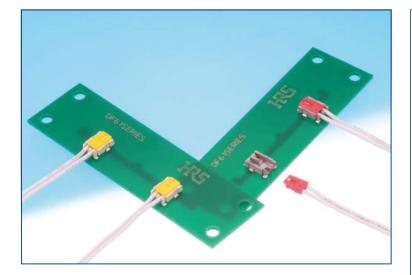
● 加市科耐德电子有限公司 Tel: 0755-28167984 www.conext.cn
Fax: 0755-29016796

邮箱:sales@conext.cn Q Q : 2403909585

Board-to-Wire Swing-Lock Connector for Low-Profile Power Source

DF61 Series



Features

1.Reinforced Swing Lock Structure

Our unique swing-lock structure cradles the wire side plug and resists the plug from becoming disengaged due to handling strain or loads.

2. Header Lock Improves Plug Retention

During mating, the header lock engages with the plug assembly. The lock is reinforced with metal which adds strength to the lock and increases the retention between the header and the plug.

3. High Current of MAX 4 Amps (AWG22)

A highly conductive material is used for the contacts. The material provides for a high current flow by reducing the contact resistance.

4.Compact Size- High Voltage

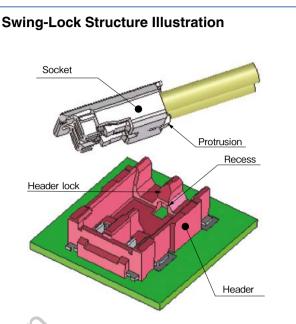
The compact 2.2 mm pitch connector has a voltage rating of 350V due to the long creep distance.

5.Solder Wicking Prevention

Header is molded in one piece. This ensures a tight fit between the contact and the header and prevents solder wicking.

Applications

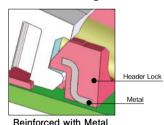
Digital cameras, digital video cameras, LED lights, laptop computers, tablet computers, portable devices, power supply equipment, etc.

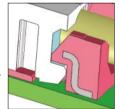


The protrusion on the bottom side of the socket fits into a corresponding recess on the header. This aligns the socket into the correct mating position.

Before Mating

After Mating

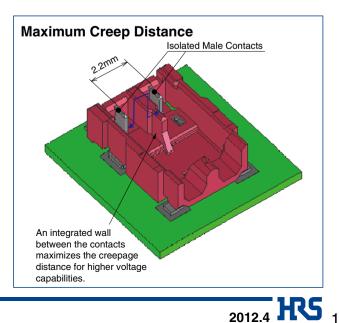




The Header pushes down the protrusion of the socket and locks it in place.

The metal fitting is partly molded in the header's housing lock.

Tensile strength of the cable: 10N or greater



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Product Specifications

Ratings	Current rating	3.2A (with AWG26) 4A (with AWG22)	Operating Temperature Range Operating Humidity Range	-35~85℃ 20~80%	(Note 1)	
	Voltage rating	AC/DC 350V	Storage Temperature Range Storage Humidity Range	-10~60℃ 40~70%	(Note 2) (Note 2)	
Items	Specifications		Cond	Conditions		
1.Insulation resistance	1000MΩ or greater	•				
2.Withstanding voltage	No flashover or breakd	own	AC500V applied for one minute	Э		
3.Contact resistance	10mΩ or less		Measured at 20mV or less, 1mA			
	No electric outage of 1μ s or more		Frequency 10-55Hz, half amplitude 0.75 mm, 10 cycles for			
4.Vibration resistance			each of 3 directions			
5.Shock resistance	No electric outage of 1μ s or more		Acceleration 490 m/s ² , 11ms; h directions	Acceleration 490 m/s ² , 11ms; half sin wave: 3 each for 3 directions		
6.Humidity resistance	Contact resistance $20m\Omega$ or less, insulation resistance $500M\Omega$ or greater		Temperature 40 \pm 2°C, humidit	y 90-95%, left fo	r 96 hours	
7.Temperature cycle	Contact resistance $20m\Omega$ or less insulation resistance $500M\Omega$ or greater		5 cycles (-55℃: 30 minutes → 9 minutes → 5-35℃: 2-3 minutes		ites → 85℃: 30	
8.Insertion/extraction life	Contact resistance20m	Ω or less	Insertion/extraction: 30 times			
9.Solder heat resistance	No melting of resin part affecting performance		e Reflow: Per recommended temperature profile Hand solder: Manual soldering iron 350±10°C for 3 second		or 3 seconds	

(Note 1) Includes temperature elevation by conduction.

(Note 2) The term "storage" refers to the long-term storage conditions of unused connectors before PCB mounting. The operating temperature range applies to connectors in non-conduction state after PCB mounting or those in temporary storage during transportation, etc.

(Note 3) The above specifications are representative for this series. Please refer to "delivery specifications" for official individual agreement.

Materials

		NN.		
■Materials	-	- 12		
Product	Part	Material	Treatment	Specification
Header	Insulator	LCP resin	Red	UL94V-0
lieddel	Contact	Brass	Tin plated	
Crimp Socket	Insulator	PBT	Red	UL94V-0
Crimp contact	Contact	Copper Alloy	Tin plated	

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DF61 Series
Board-to-Wire Swing-Lock Connector for Low-Profile Power Source

Product Number Structure

See Pages 4-6 of this catalog to select and order specific items.

Header	r							
DF	61	—	*	Ρ	-	2.2	V	_
1	2		3	4		6	6	_
1 Series	Name:	DF						Pitch: 2.2mm
2 Series	No.: 61							6 Termination form
3 Numb	er of co	ontacts	s: 2					V: SMT straight type
4 Type c	of conne	ector						
P: Hea	lder							

•Crimp Housing

<u>DF 61 - * S</u>	– <u>2.2</u> <u>C</u>	-
	56	
Series Name: DF		5 Pitch: 2.2mm
2 Series No.: 61		6 Termination form
8 Number of contacts: 2		C: Crimp case
 Type of connector Socket 		
DF 61 – <u>2630</u>	SCF	conett
Applicable Wire Size 2630:AWG# 26-30		Porm Type/Package Type SCF: Socket crimp contact/reel
	N.	•

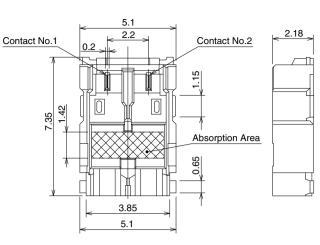
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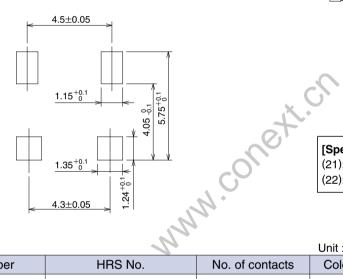
DF61 Series
Board-to-Wire Swing-Lock Connector for Low-Profile Power Source

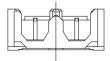
Straight Header (SMT)





Recommended PCB Dimensions(t=1mm)





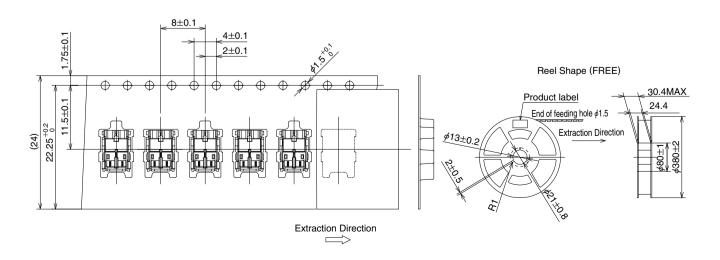
[Specification No.]

(21):Tin plated, emboss package, mold color: red (22):Tin plated, emboss package, mold color: yellow

			Unit : mm
Product Number	HRS No.	No. of contacts	Color
DF61-2P-2.2V(21)	CL666-5001-1-21	2	Red
DF61-2P-2.2V(22)	CL666-5001-1-22	2	Yellow

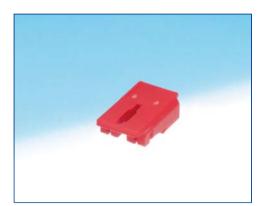
Note: For embossed package products, please order in full reel quantities. (1 reel = 3000 pcs.).

Reel Dimensions



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Socket







3.95

6.29

[Specification No.]

(01): 1,000 connectors per pack, mold color: red (02): 1,000 connectors per pack, mold color: yellow

LI T

2.26

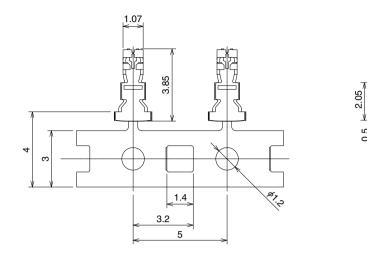
		X	5			
		OT	Unit : mm			
Product Number	HRS No.	No. of contacts	Color			
DF61-2S-2.2C(01)	CL666-5002-4-01	2	Red			
DF61-2S-2.2C(02)	CL666-5002-4-02	2	Yellow			
Note: Please order by full pack	Note: Please order by full packs (1,000 pcs./pack)					
	AN AN AN					

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DF61 Series Board-to-Wire Swing-Lock Connector for Low-Profile Power Source

Crimp contact



Tel

[Specification No.] None: 20,000 contacts per reel

0.15

Product Number	HRS No.	Туре	Quantity	Treatment
DF61-2630SCF	CL666-5003-7-00	Reel contact	20,000 contacts per reel	Tin plated
DF61-2226SCF	Under development	Reel contact	20,000 contacts per reel	Tin plated

(Note1) Please order in full reel quantities. (1 reel = 20,000 pcs.).

• Applicable Wire (Tin plated soft copper wire)

Conductor Size	Coating Diameter
AWG# 26-30	∮ 0.7mm - 1.1mm

Note: Please consult with our a Hirose sales representative when using wires other than those recommended below.

●Applicable wires: UL10368 AWG# 26 and AWG# 29

•Strip Length 1.3 - 1.7mm

■Applicable Crimping Tools

Types	Product Number	HRS No.	Applicable Contact
Applicator	AP105-DF61-2630S	CL901-4620-7-00	DF61-2630SCF
Press Unit	CM-105	CL901-0005-4-00	
Hand Tool	Under development		DF61-2630SCF
Extraction Tool	DF-C-PO(B)	CL550-0179-2-00	DF61-2630SCF

Note: Problems resulting from the use of non-authorized tools will not be warranted.

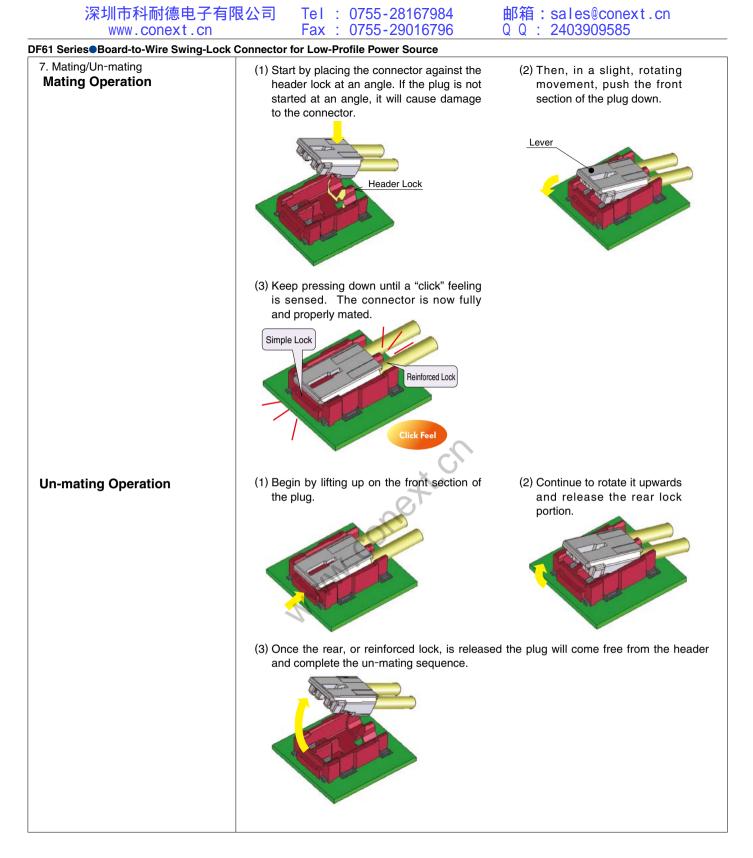
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Operating Precautions

DF61 Series
Board-to-Wire Swing-Lock Connector for Low-Profile Power Source

1. Recommended Temperature Profile (Lead-free soldering possible)	10sec MAX	
(F F,	MAX 250	
	250	
	220°C	
	200	
	180°C – – – – – – – – – – – – – – – – – – –	
	\mathbf{H}	
	50	
	0	
	TIME(se	ec)
	90~120sec 60sec MAX PRE-HEATING TIME SOLDERING TIME	
 Recommended Hand Solder Conditions Recommended Screen Thickness, Aperture Opening Rate (Pattern Area Ratio) 	3. Pre-heating Area: 150-180°C, 90-120 sec. 4. Number of Operation: Twice or less * The contact lead area was measured. The conditions may change depending on the types and many cream solder, PCB size, and conditions of other materials used for Please fully check the soldering condition before use. [Remarks 1] This temperature profile is our recommended value. Soldering iron temperature: $350 \pm 10^{\circ}$ C, soldering time: within 3 second Thickness 0.1 mm, aperture opening rate: 100%	or soldering.
4. PCB Warpage	Max 0.02 mm at the center of connector with the both edges of the the baseline	connector as
5. Cleaning Condition	Cleaning with IPA is possible. (Cleaning is not recommended as it the feel of insertion/extraction, etc. Please consult with us when usir of cleaning agents.)	
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5. Cleaning Condition6. Precautions	Cleaning with IPA is possible. (Cleaning is not recommended as it the feel of insertion/extraction, etc. Please consult with us when usin of cleaning agents.) In order to maintain the performance reliability, do not insert the into the crimp socket at a slant angle.	ng other types
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HIROSE ELECTRIC CO.,LTD.

6-3,Nakagawa Chuoh-2-Chome,Tsuzuki-Ku,Yokohama-Shi 224-8540,JAPAN TEL: +81-45-620-3526 Fax: +81-45-591-3726 http://www.hirose.com http://www.hirose-connectors.com